

## Specification of Electret Condenser Microphone (RoHS Compliance&Halogen-Free)

Customer Name :

Customer Model :

GoerTek Model : B4013AM423-103

Tel : + 86 536 3051234

E- Mail : [goertek@goertek.com](mailto:goertek@goertek.com)

Website: <http://www.goertek.com>

Address: No.268 Dongfang Road, High-Tech Industry  
Development District, Weifang, Shandong, P.R.C.

## Restricted

### 1 Security warning

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### 2 Publication history

Version	Date	Description	Design	Approval
1.0	2018.07.04	New Design	Jery. Yang	Near.An

### 3 Symbols Show

Symbols	Show
©	Signify Customer's Special Characteristic.
Ⓒ	Signify GoerTek Special Characteristic.

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## PRODUCT SPECIFICATIONS

Type : Electret Condenser Microphone

Model: B4013AM423-103

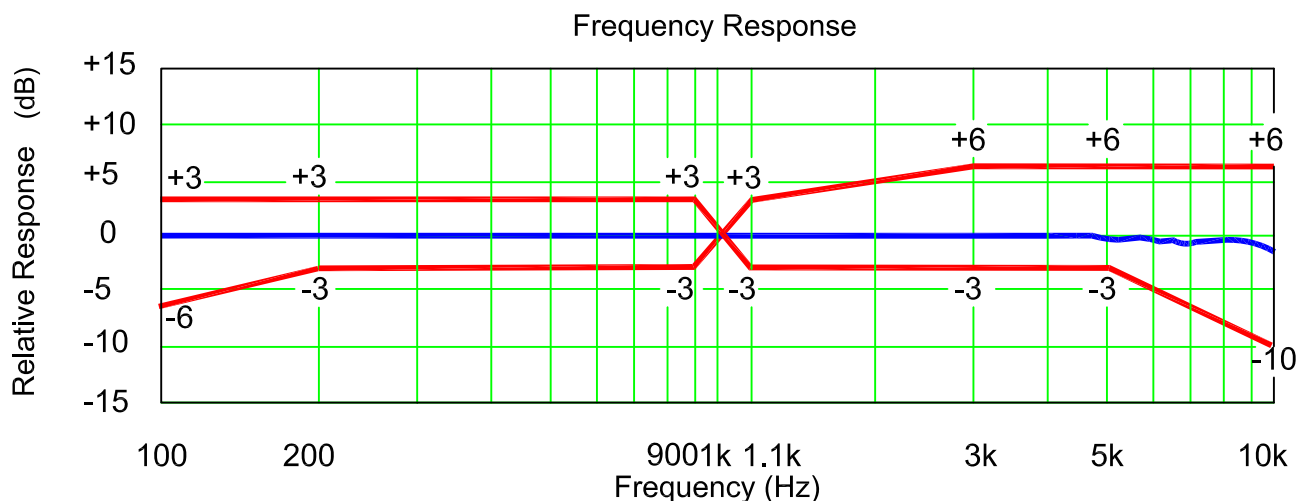
### 1 Test Condition ( $V_s=2.0V$ , $R_L=2.2k\Omega$ , $L=50cm$ )

Standard Conditions (Re. IEC 60268-4)	Temperature	Humidity	Air pressure
Environment Conditions	+15°C ~ +35°C	25%RH ~ 75%RH	86kPa ~ 106kPa
Judgement Conditions	+20°C ±2°C	60%RH ~ 70%RH	86kPa ~ 106kPa

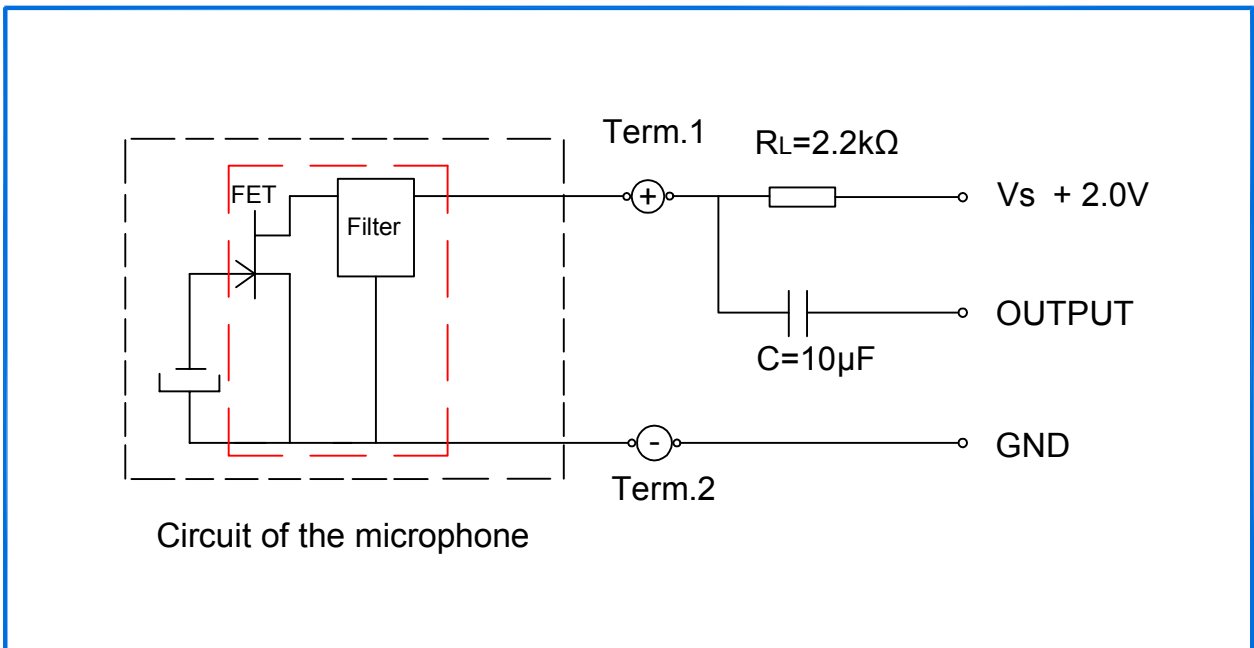
### 2 Electrical and Acoustical Characteristics

Item	Symbol	Test Conditions	Min	Typ	Max	Unit
Sensitivity	S	f=1kHz, Pin=1Pa	-45	-42	-39	dB 0dB=1V/Pa
Output Impedance	Zout	f=1kHz, Pin=1Pa			2.2k	$\Omega$
Directivity	D( $\theta$ )	Omnidirectional				dB
Current Consumption	I				500	$\mu A$
S/N Ratio	S/N(A)	f=1kHz, Pin=1Pa A-Weighted Curve	58			dB
Decreasing Voltage Characteristic	$\Delta S$	f=1kHz, Pin=1Pa $V_s=2-1.5V$	0		3	dB
Operating Voltage Range	$V_s$		1.1		5.0	V
Distortion	THD	f=1kHz, Pin=94dB			1	%
		f=1kHz, Pin=115dB			5	%
		f=1kHz, Pin=120dB			10	%

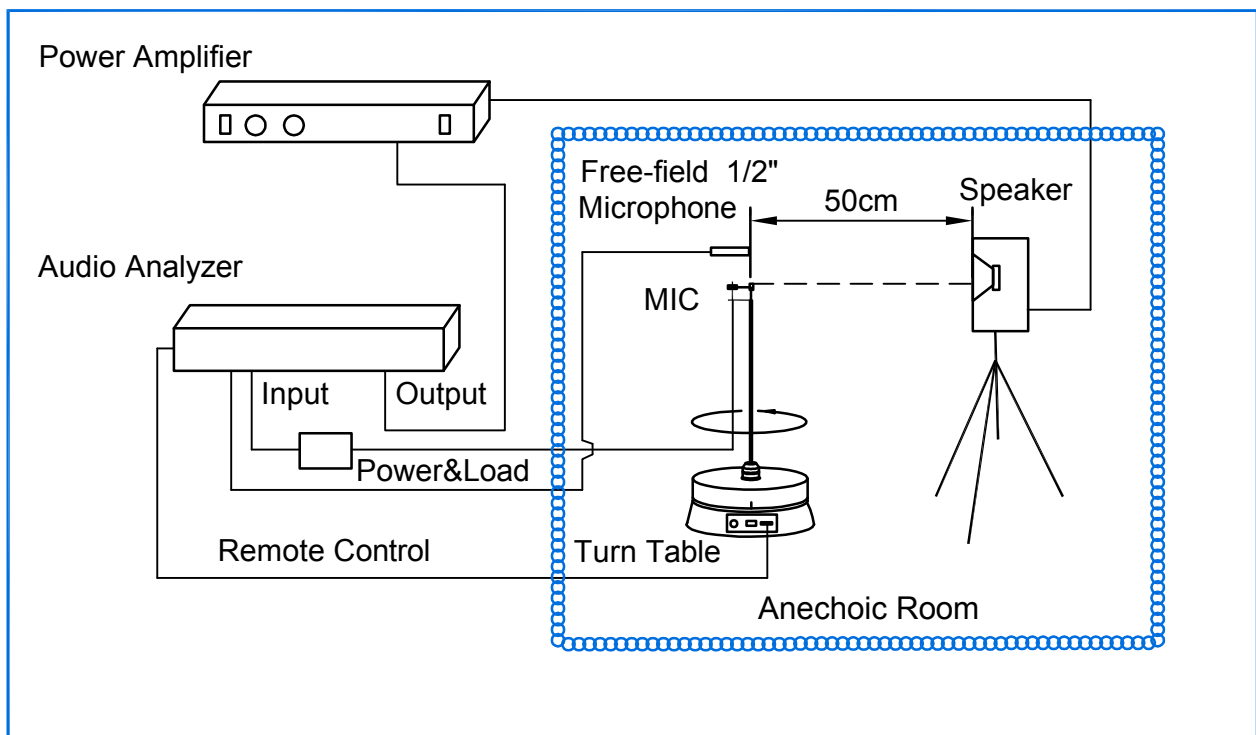
### 3 Frequency Response Curve and Limits



## 4 Measurement Circuit

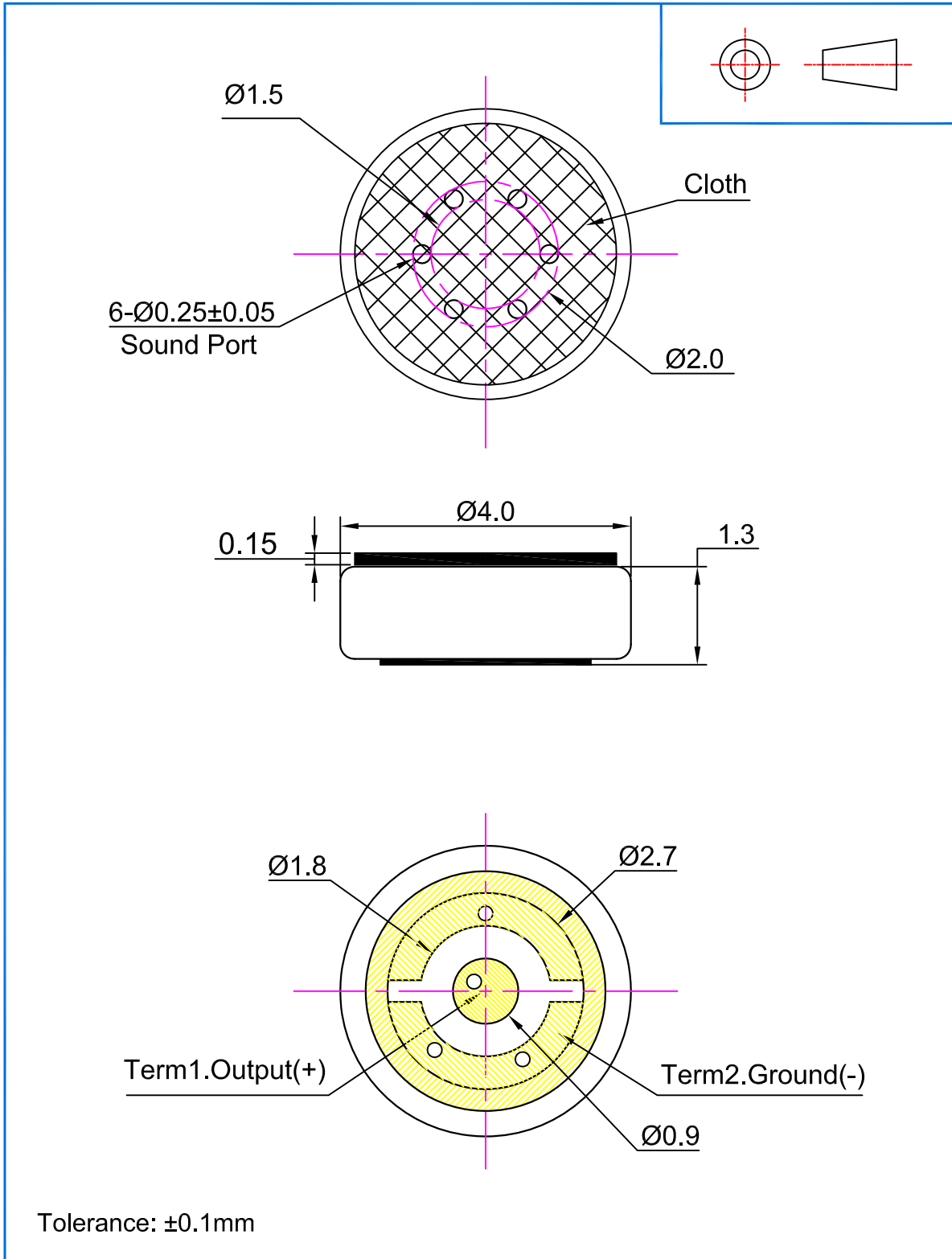


## 5 Test Setup Drawing



**6 Mechanical Characteristics**

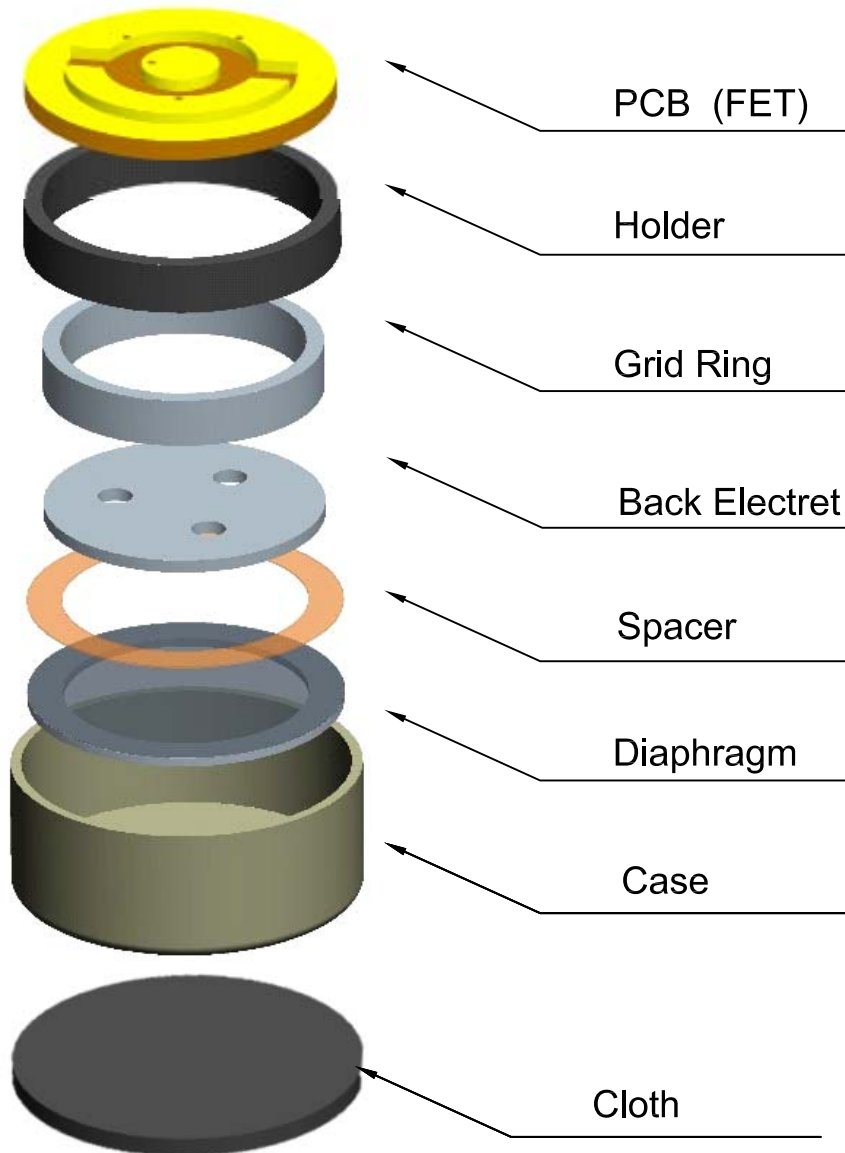
**6.1 Appearance Drawing (Unit: mm)**



**6.2 Weight**

The weight of the MIC is less than 0.2g.

7 Structure of SMD MIC



No.	Item	Qty.	Vendor	Material
1	PCB	1	KJ	FR-4
2	Holder	1	Yuyuan	HTN
3	Grid Ring	1	Yuyuan	Brass with nickel-plated
4	Back Electret	1	Yinhe	Stainless steel with PTFE
5	Spacer	1	Wanda+GoerTek	PI
6	Diaphragm	1	GoerTek	Stainless ring +PPS with nickel-plated
7	Case	1	ABE	Brass with nickel-plated
8	Cloth	1	Hailiqi	/

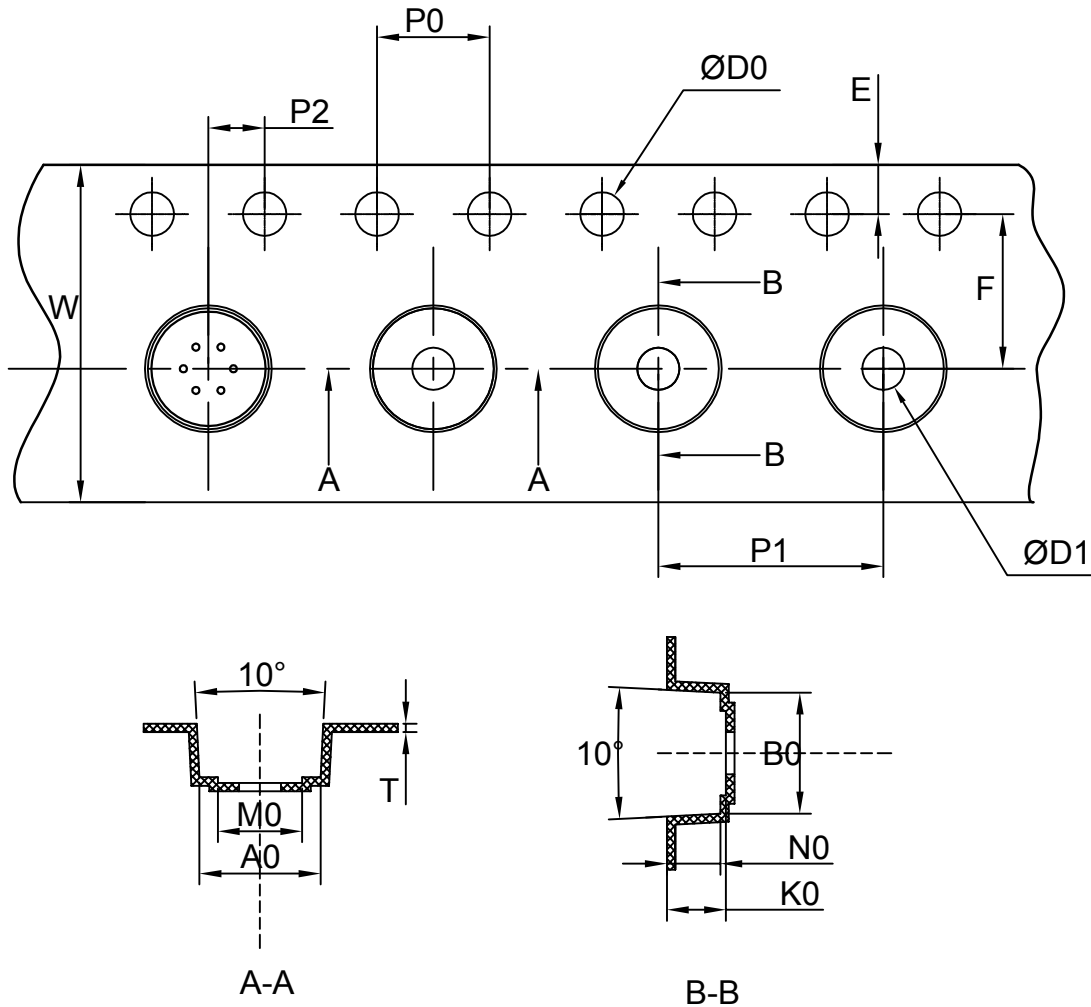
## 8 Reliability Test

<p>8.1 Vibration Test</p>	<p>To be no interference in operation after vibrations, 10Hz to 55 Hz for 1 minute full amplitude 1.52mm, for 2 hours at three axes in state of standard packing, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.2 Drop Test</p>	<p>To be no interference in operation after dropped to steel plate each one time from 1.5 meter height, 12 times, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.3 Temperature Test</p>	<p>a) After exposure at <math>+85\text{ }^{\circ}\text{C}</math> for 200 hours, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%) b) After exposure at <math>-40\text{ }^{\circ}\text{C}</math> for 200 hours, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.4 Humidity Test</p>	<p>After exposure at <math>+60\text{ }^{\circ}\text{C}</math> and 90~95% relative humidity for 200 hours, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.5 Temperature Cycle Test</p>	<p>After exposure at <math>-40\text{ }^{\circ}\text{C}</math> for 30 minutes, at <math>20\text{ }^{\circ}\text{C}</math> for 10 minutes, at <math>+85\text{ }^{\circ}\text{C}</math> for 30 minutes, at <math>20\text{ }^{\circ}\text{C}</math> for 10 minutes, 5 cycles, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.6 Temperature Shock Test</p>	<p>After exposure at <math>-40\text{ }^{\circ}\text{C}</math> for 60 minutes, at <math>+85\text{ }^{\circ}\text{C}</math> for 60 minutes (change time 20 seconds), 32 cycles, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>
<p>8.7 ESD Shock Test</p>	<p>The microphone under test must be discharged between each ESD exposure without ground. (contact: <math>\pm 8\text{kV}</math>, air: <math>\pm 15\text{kV}</math>) There is no interference in operation after 10 times exposure.</p>
<p>8.8 Reflow Test</p>	<p>Adopt the reflow curve of item 11.3, after two reflows, sensitivity to be within <math>\pm 3\text{dB}</math> from initial sensitivity. (The measurement to be done after 2 hours of conditioning at <math>+15\text{ }^{\circ}\text{C} \sim +35\text{ }^{\circ}\text{C}</math>, R.H 25%~75%)</p>



## 9 Package

### 9.1 Taping Specification



the dimensions as follows:

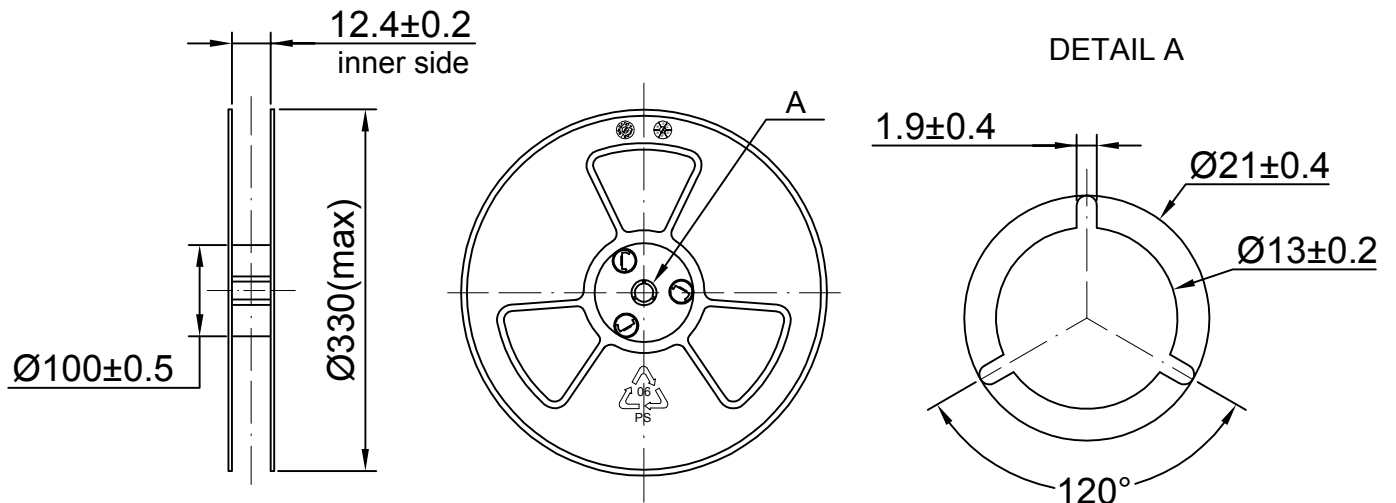
ITEM	W	E	F	ØD0	ØD1
DIM(mm)	12.0±0.30	1.75±0.10	5.50±0.05	1.50±0.10	1.55±0.10
ITEM	P0	10P0	P1	A0	B0
DIM(mm)	4.00±0.10	40.00±0.20	8.00±0.10	4.20±0.05	4.20±0.05
ITEM	K0	P2	T	M0	N0
DIM(mm)	1.70±0.10	2.00±0.05	0.35±0.05	3.00±0.05	1.50±0.1

## 9.2 Reel Dimension

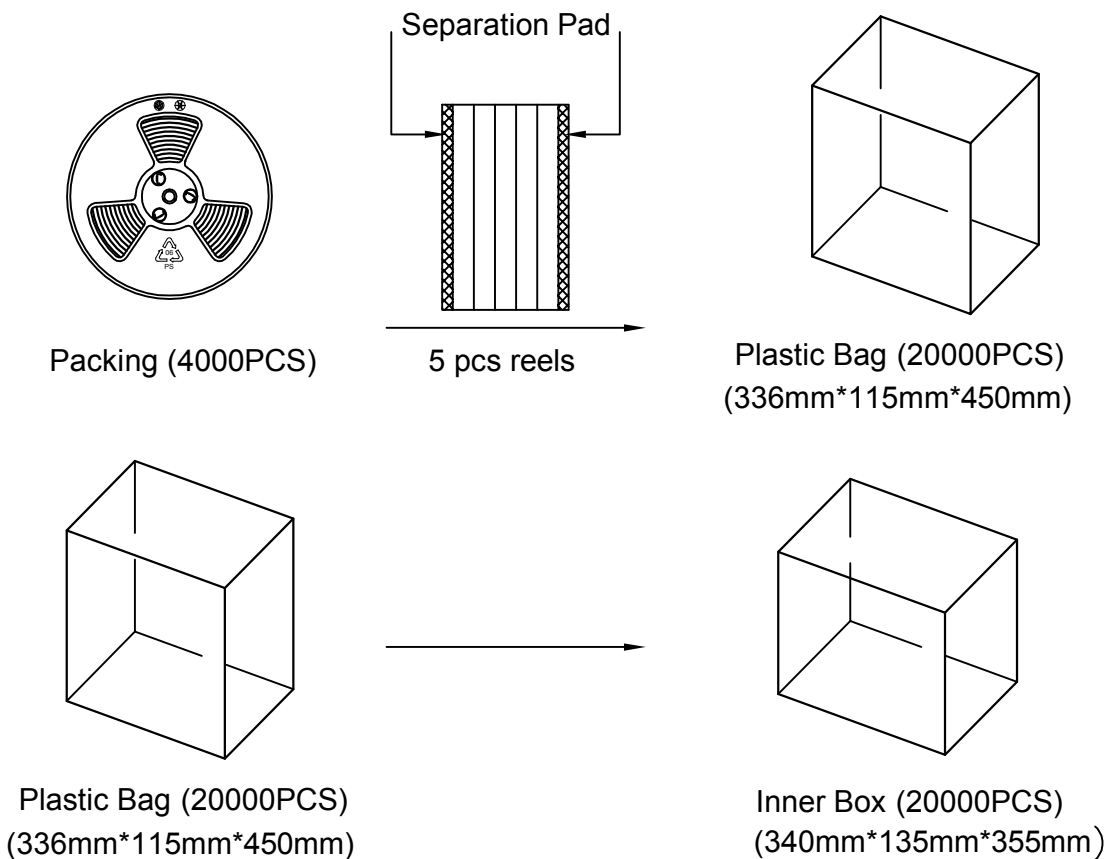
7 " reel for sample stage

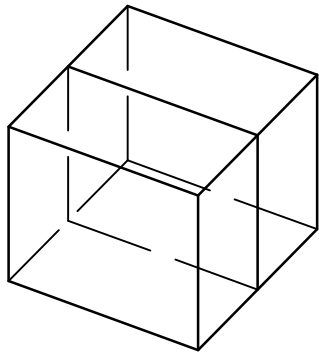
13 " reel will be provided for the mass production stage

The following is 13" reel dimensions (unit:mm)

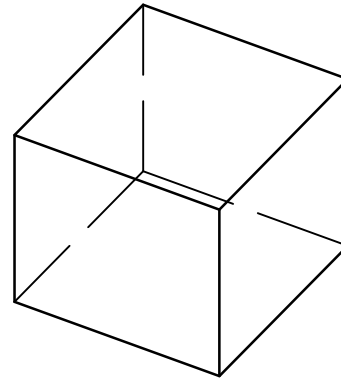
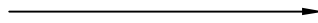


## 9.3 The content of box(13" reel)





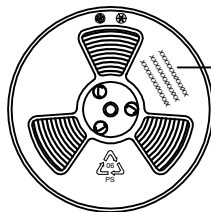
Two Inner Box(40000PCS)



Outer Box(40000PCS)  
(370mm\*300mm\*390mm)

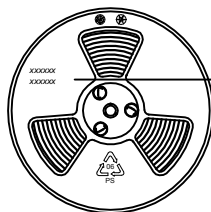
## 9.4 Packing Explain

### 9.4.1 The label content of the reel



the content including:  
product type, Lot, customer P/N;  
and other essential information such as Quantity,  
Date etc.

### 9.4.2 The RoHS&HF Label



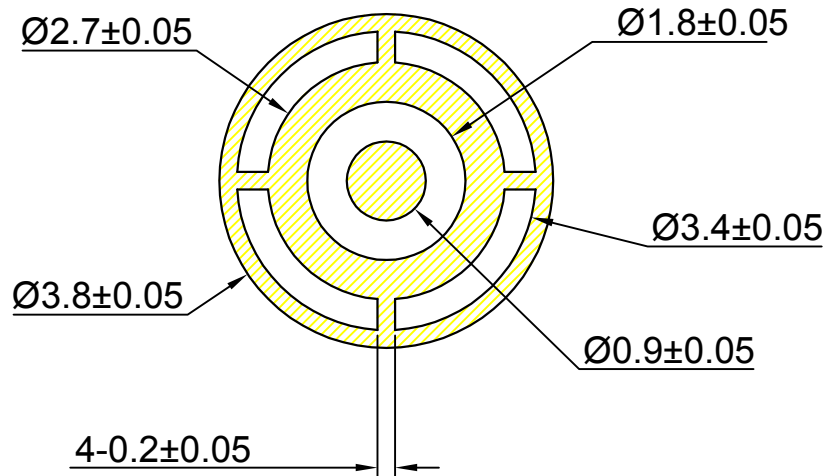
RoHS & HF  
compliance mark

## 10 Stock and Transportation

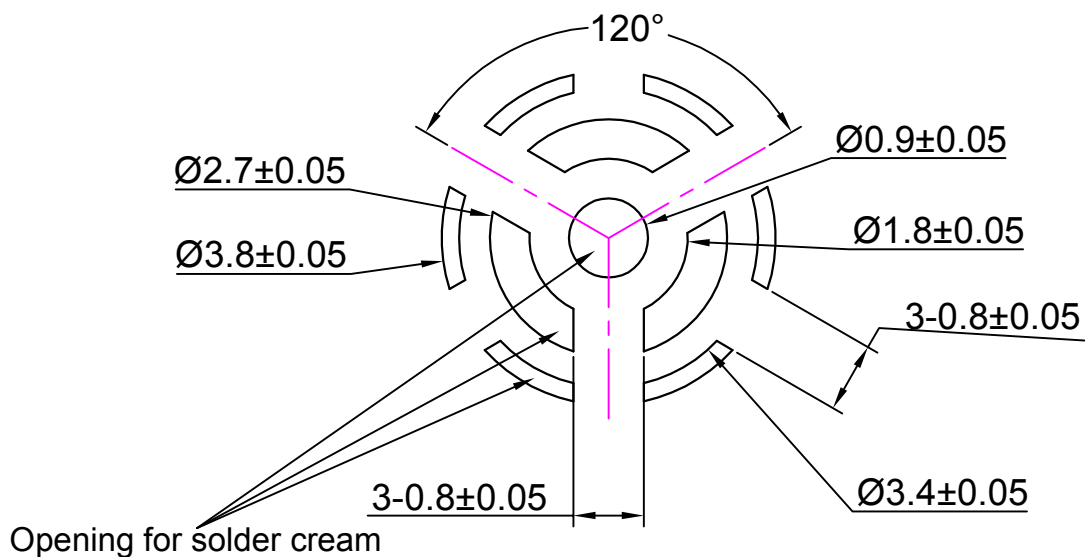
- 10.1 Keep ECM in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field.
- 10.2 The ECM with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.
- 10.3 Storage Temperature Range: -40 °C~+85°C
- 10.4 Operating Temperature Range: -30°C~+70°C

## 11 Land Pattern Recommendation (Unit: mm)

### 11.1 Soldering Surface - Land Pattern



### 11.2 Metal Mask Pattern



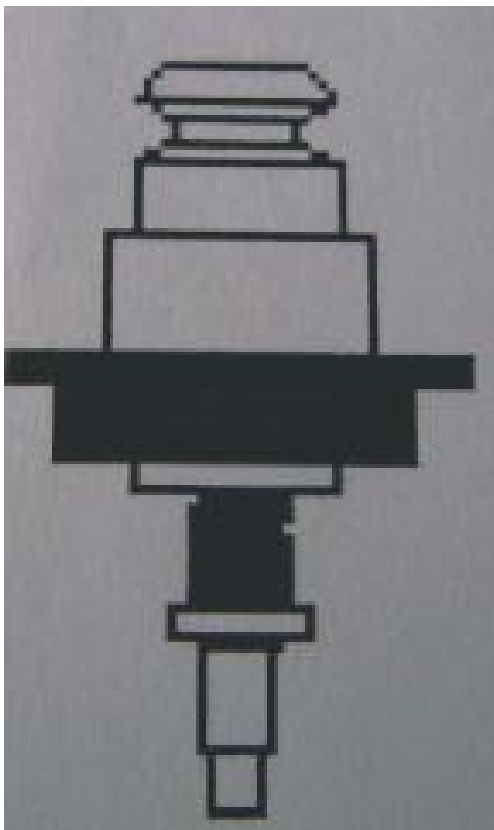
- thickness of metal mask: 0.1mm

## 12 Recommend Soldering

### 12.1 Soldering Machine Condition

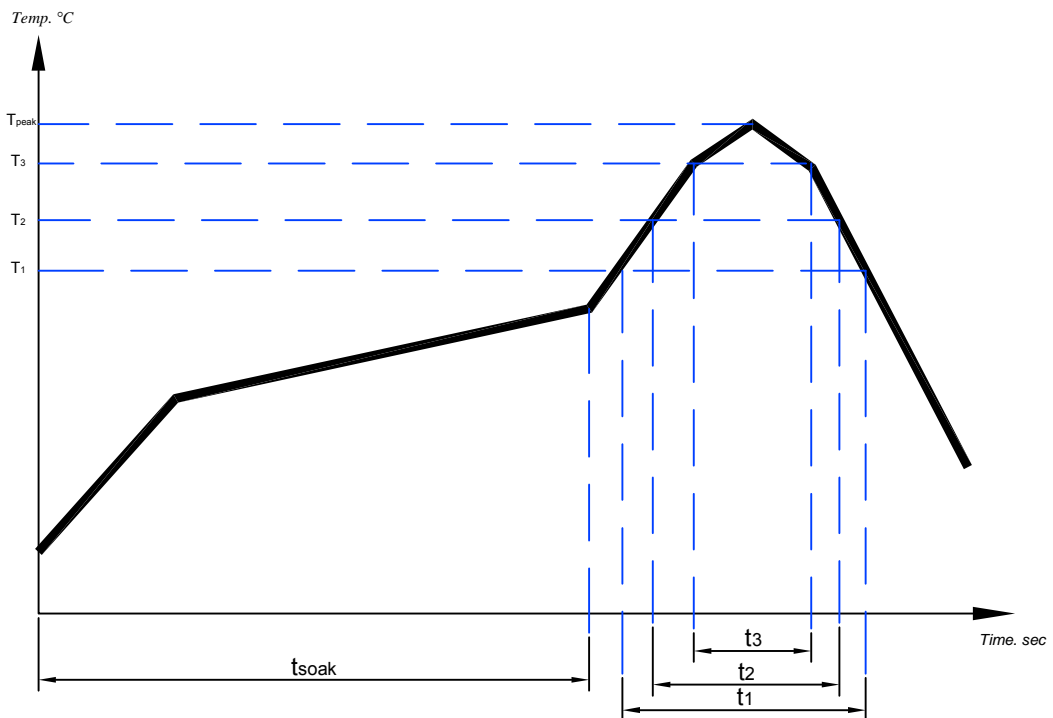
Temperature control	8 zones
Heater Type	Hot Air
Solder Type	Lead-free

### 12.2 The pattern of the nozzle



dimension of nozzle:504  
external diameter: 1.5mm;  
inside diameter: 1.0mm;  
Pick up position:bottom border of microphone

## 12.3 Reflow Profile



### Pb-free reflow profile requirements for soldering heat resistance

Parameter	Reference	Specification
Average Temperature Gradient in Preheating	---	2.5°C/s
Soak Time	$t_{soak}$	2-3 Minutes
Time Above 217 °C	$t_1$	Max 60s
Time Above 230 °C	$t_2$	Max 50s
Time Above 250 °C	$t_3$	Max 10s
Peak Temperature In Reflow	$T_{peak}$	255 °C (-0/+5 °C)
Temperature Gradient In Cooling	---	Max -5 °C/s

When SMD MIC is soldered on PCB, the reflow profile is set according to solder paste and the thickness of PCB etc.

## 13 Cautions when using SMD MIC

### 13.1 X-ray inspection

The microphone should not be subjected to X-ray inspection. If it is absolutely necessary to do inspection using X-ray, the setting conditions with the following conditions:

Distance: >0.08meter;

Current: <0.080mA;

Time: <30s;

Voltage: <80kV.

### 13.2 Board wash restrictions

It is very important not to wash the PCBA after reflow process, or this could damage the microphone.

### 13.3 Nozzle restrictions

It is very important not to pull a nozzle over the post hole of the microphone. or this could damage the microphone.

### 13.4 Others restrictions

The pressure on the MIC shouldn't be more than 10N; The connecting between the institution and MIC should use rubber or Poron.

## 14 Output Inspection standard

output inspection standard is excuted according to <<ISO2859-1:1999>>.